

nibs22

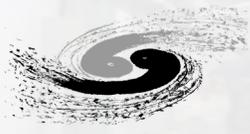


Over 7200 hours commissioning of RF-driven negative hydrogen ion source developed at CSNS

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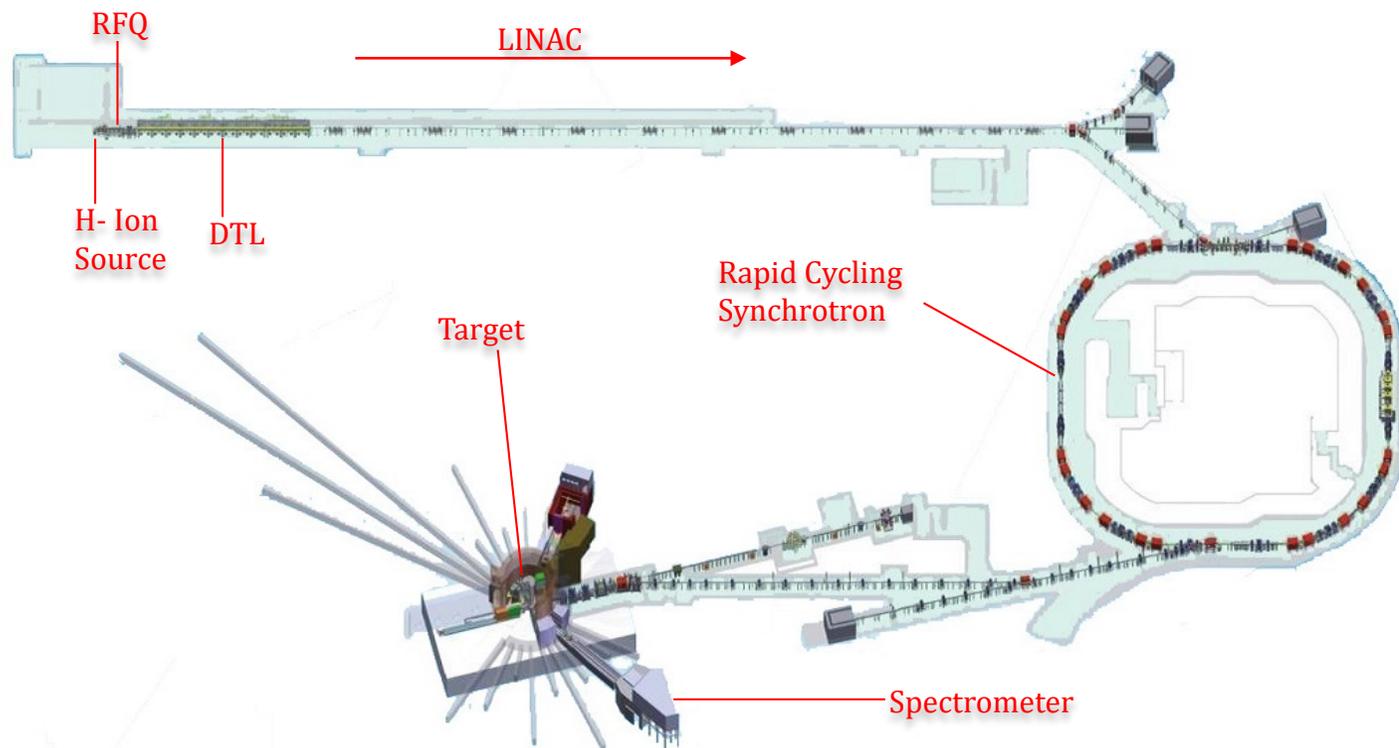
- Introduction to the CSNS accelerator and the front end system
- Structure of the ion source
- Operation status in last run cycle (2021.9-2022.7)
- Issues in operation and machine study
- Recent development
- Summary



Motivation

$$\text{Beam-power} = \text{Current} \times \text{Energy} \times \text{Pulse-width} \times \text{Repetition} \times \text{Chopping factor}$$

↓ ↓ ↓ ↓ ↓ ↓
 500 kW 40~55 mA 1.6 GeV 500-600 us 25 Hz 50-60%

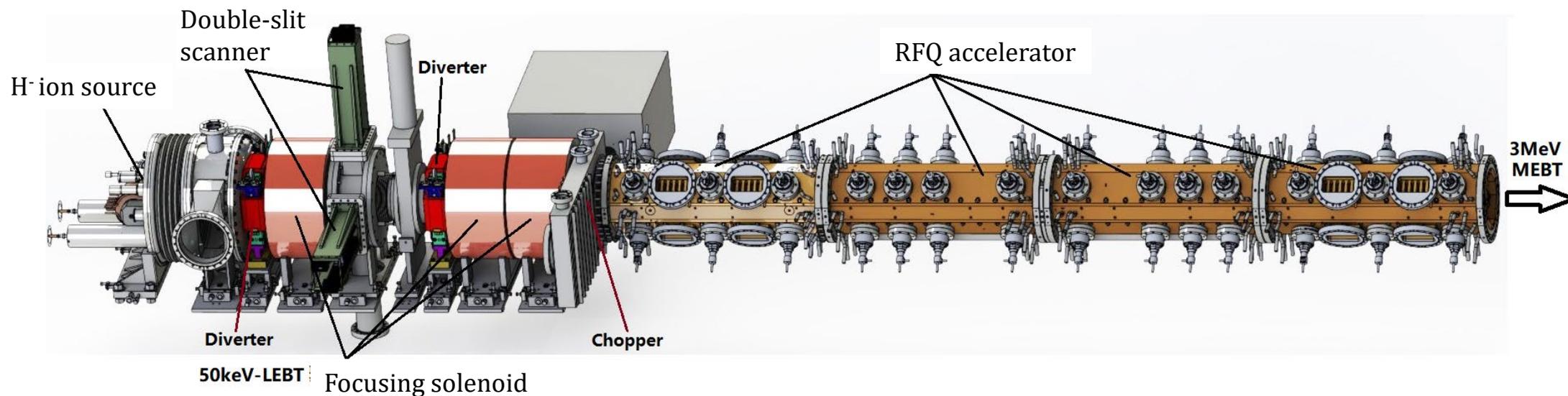


Parameters	CSNS-I	CSNS-II
I.S. Current (mA)	>12	40~55
Repetition Rate (Hz)	25	25
Pulse-width (us)	415	500-600
Chopping Factor	42%	35-50%
LINAC Components	R.T.	R.T.+SC
LINAC-energy (MeV)	80	300
RCS-energy (GeV)	1.6	1.6
Beam Power (kW)	100	500



The front end system

The front end of the CSNS accelerator



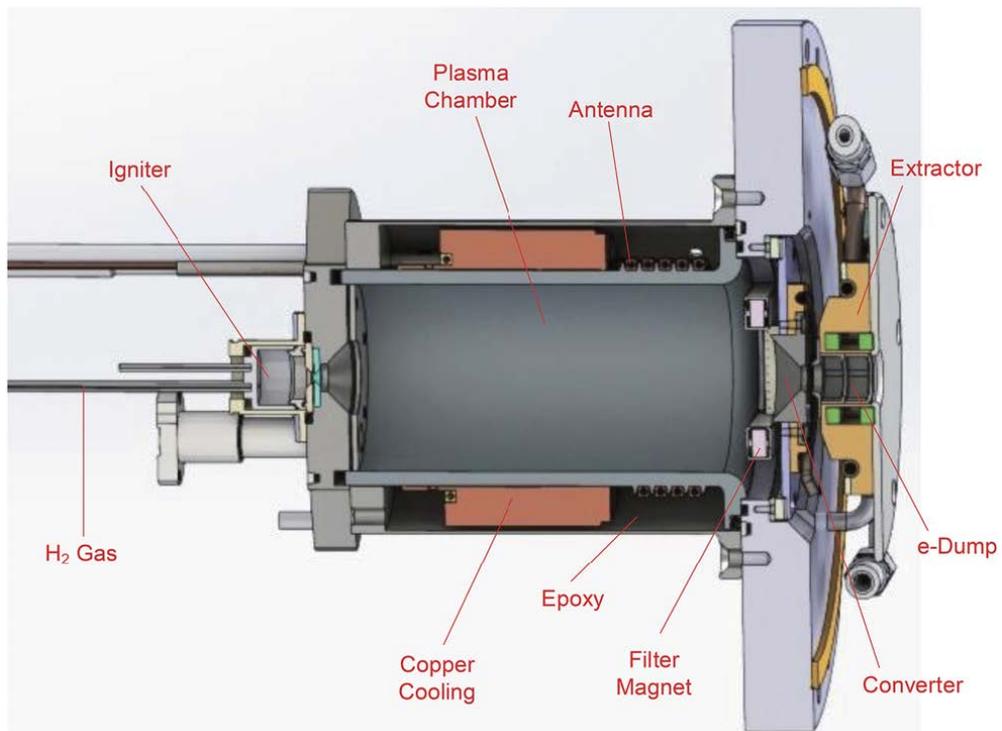
- The LEBT has 3 solenoids, initially designed for the former penning ion source.
- Since Sep. 8th 2021, the penning source has been replaced by RF-driven H⁻ ion source.
- Currently the beam power on target is 125 kW, and 150 kW is ready for service.
- In operation, the ion source produces 37~40 mA, and throttled to 12 mA by a collimator installed before RFQ.



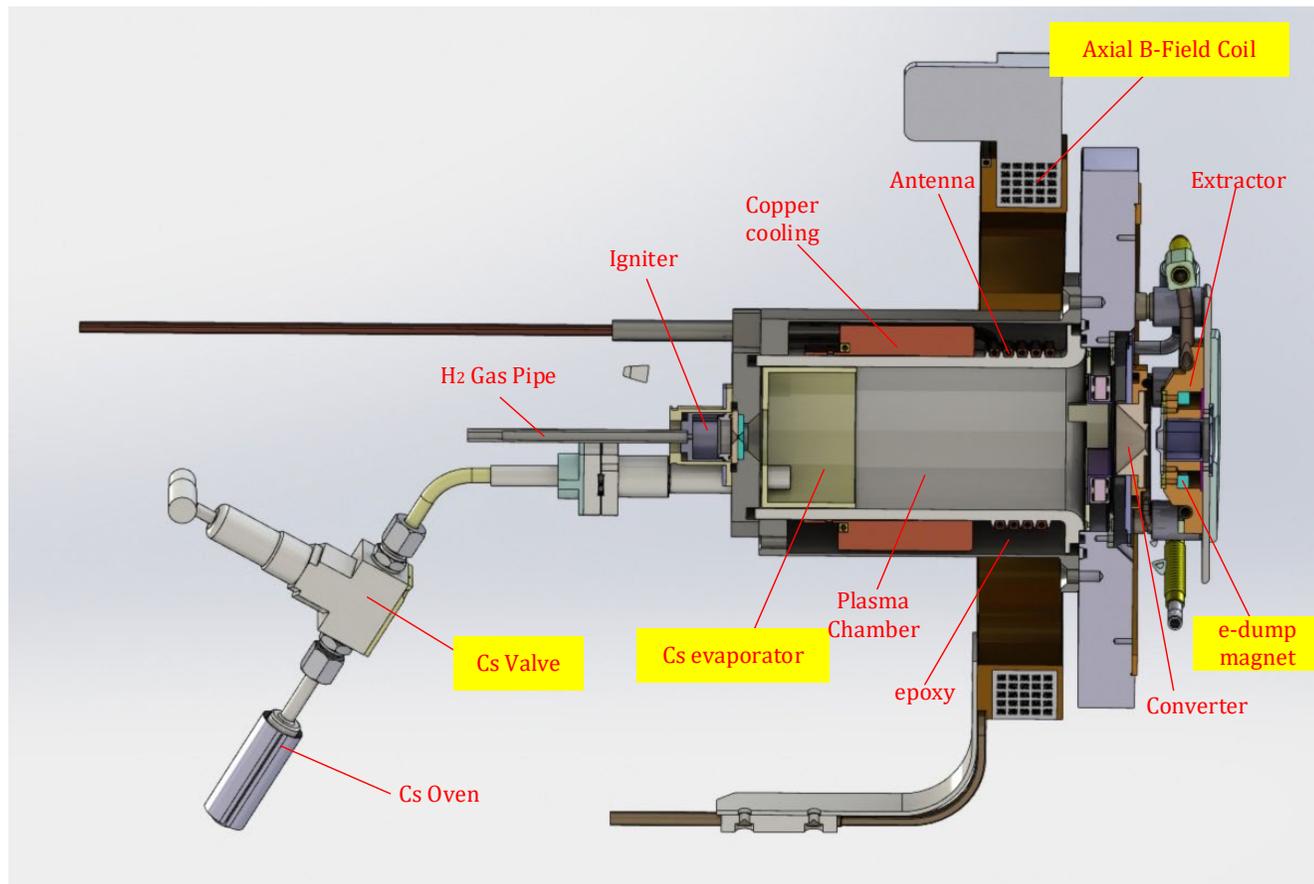
Structure of the ion source

- Silicon-nitride plasma chamber.
- Insulated by epoxy with high thermal conductivity.
- Glow discharge igniter in gas line.
- One pair permanent magnet for e-dumping (since 2021)
- Cs evaporator is used (since 2021, improved 2022)

- Axial B-field coil (since 2020)
- Cs injection system is used (since 2020).
- Remove cusp magnets (since 2021).



Ver200



Ver2022



Structure of the ion source

Why silicon nitride?

- High flexural strength (900 MPa)
- Relative high thermal conductivity (16~60 W/m.K)
- High heat shock (800 °C)
- Inert to acid or alkali (when <900 °C)
- Low porosity (<5%), low degas rate



Before epoxy filled



Al₂O₃ (left) and Si₃N₄ (right) plasma chambers for thermal and mechanical test

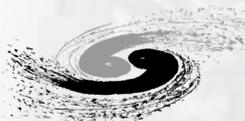
Incipient concerns in ceramic selection in 2016:

Al₂O₃—Possibly break during the heating up and cooling down for high power operation.

AlN—Possibly react with alkali (CsOH), absorb water in room temperature. It needs to be heated up in vacuum to degas before use, which is critical for Cs injection.

Si₃N₄ is chosen because it has no such uncertainties, although it is hard to machine.

Recently we start to verify these uncertainties of other ceramics.



Structure of the ion source

Operation parameters in Apr. 28, 2022, max temperature of the chamber is 43 °C, average power 535 W.

放电室温度

转换电极	PE Temp.	腔体槽	腔体中	Max Temp.
86.40	86.40	37.18	43.10	43.10

Cs Temp.

铯锅	84.82	85.00	电源及PID参数
管道1	173.02	173.00	
管道2	190.42	190.00	
转换电极	86.40	86.00	

铯氢比 0.315 Cs852/H434
氧氢比 0.224 O777/H434

温度单位：摄氏度

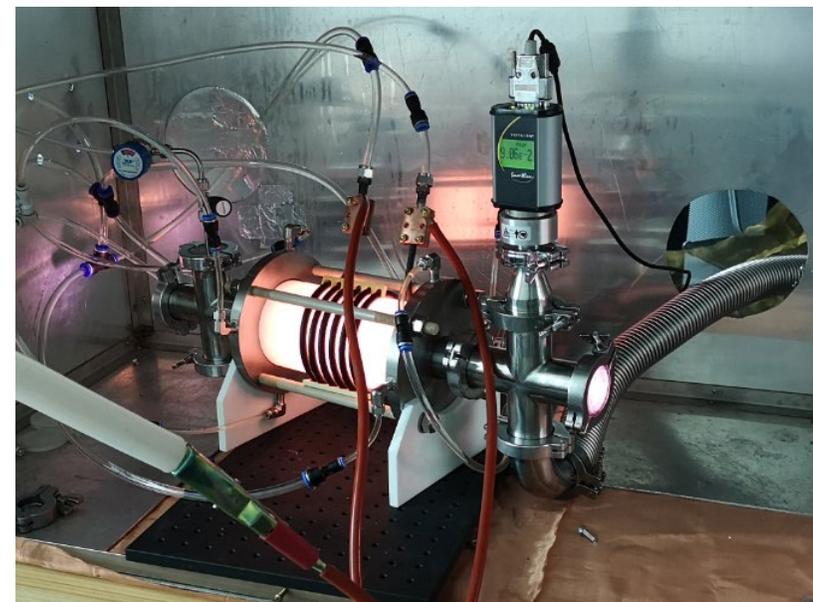
氢气流量计

回收	H2 Flow	阀控	管道压力
20.87 sccm	20.87 sccm	<input checked="" type="checkbox"/>	0.028 MPa
设置	21	关闭	
		<input type="checkbox"/>	

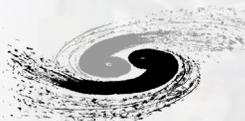
射频电源

发射功率	RF Power	电源开	电源关
31.45 kW	31.45 kW	<input checked="" type="checkbox"/>	<input type="checkbox"/>
反射功率	0.21 kW	发射开	发射关
0.21 kW	0.21 kW	<input checked="" type="checkbox"/>	<input type="checkbox"/>
平均反射	-19.77 dBm	射频开	射频关
-19.77 dBm	-19.77 dBm	<input checked="" type="checkbox"/>	<input type="checkbox"/>

RF test with an alumina tube in IPP Hefei, China. Alumina can not block visible light and ultraviolet (>250 nm). So another concern arises—ultraviolet photon possibly damages the molecule-chain of epoxy surrounding the chamber.

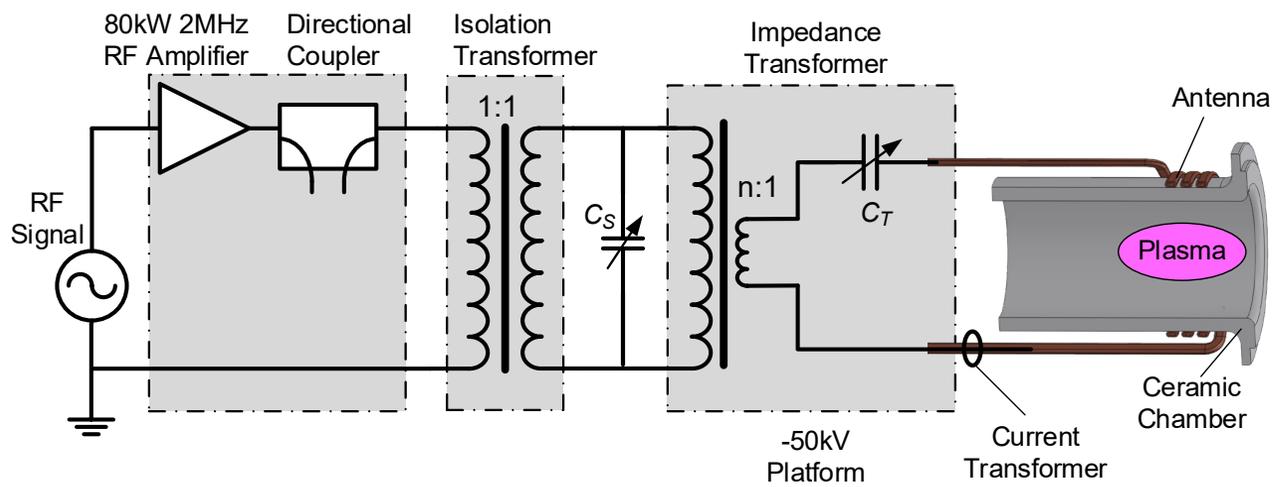


Si₃N₄ is opaque to ultraviolet photon from the hydrogen plasma. In thermal and mechanical aspects, alumina is also able to stand 1500 W average power with the same design. A long term (>1 year) high power (>1000W avg.) test is carried out in CSNS.

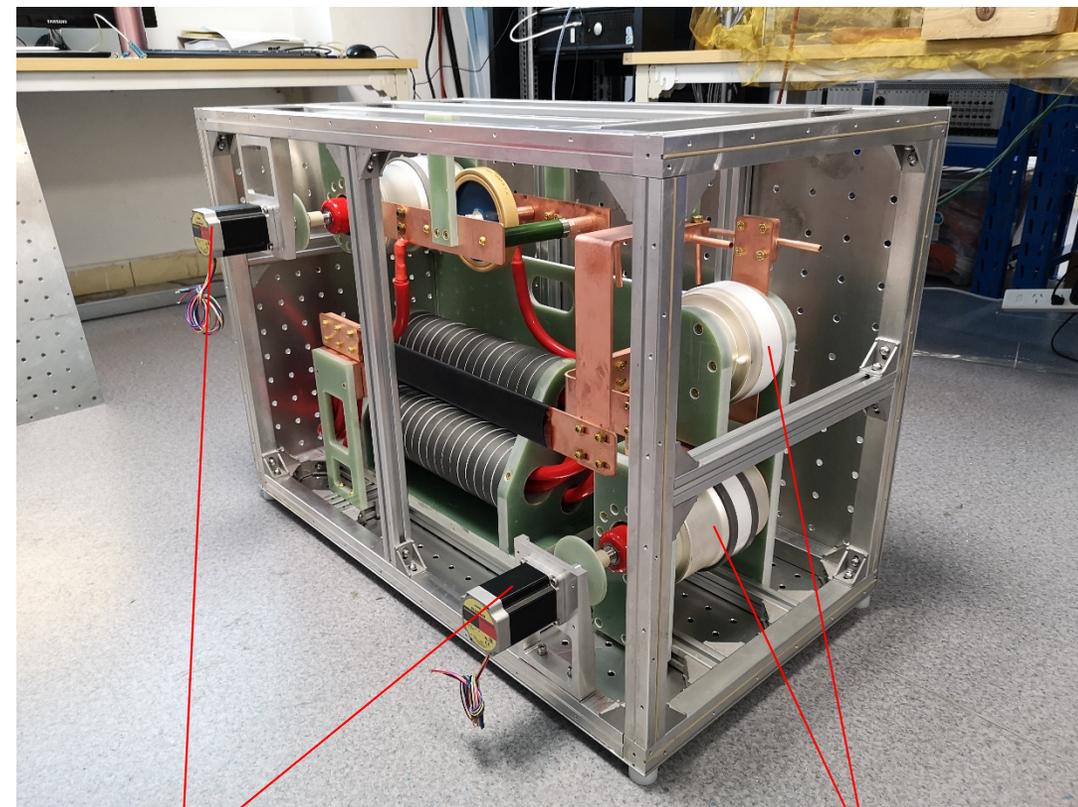


Structure of the ion source

RF power matching circuit



- Maximum 80 kW RF power
- 1.8-2.2 MHz tunable
- 3:1 turn-ratio
- 100 kV isolation tested
- Above 90% power transmission after RF amplifier



Step motor

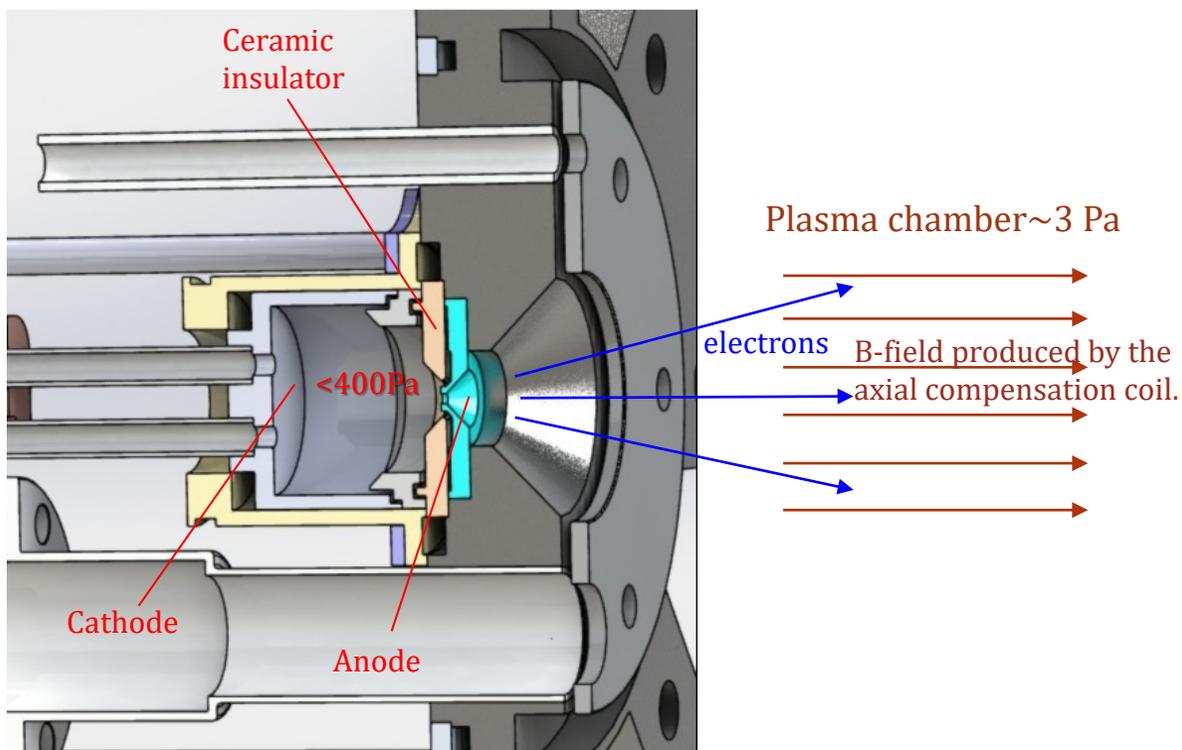
Ceramic capacitor



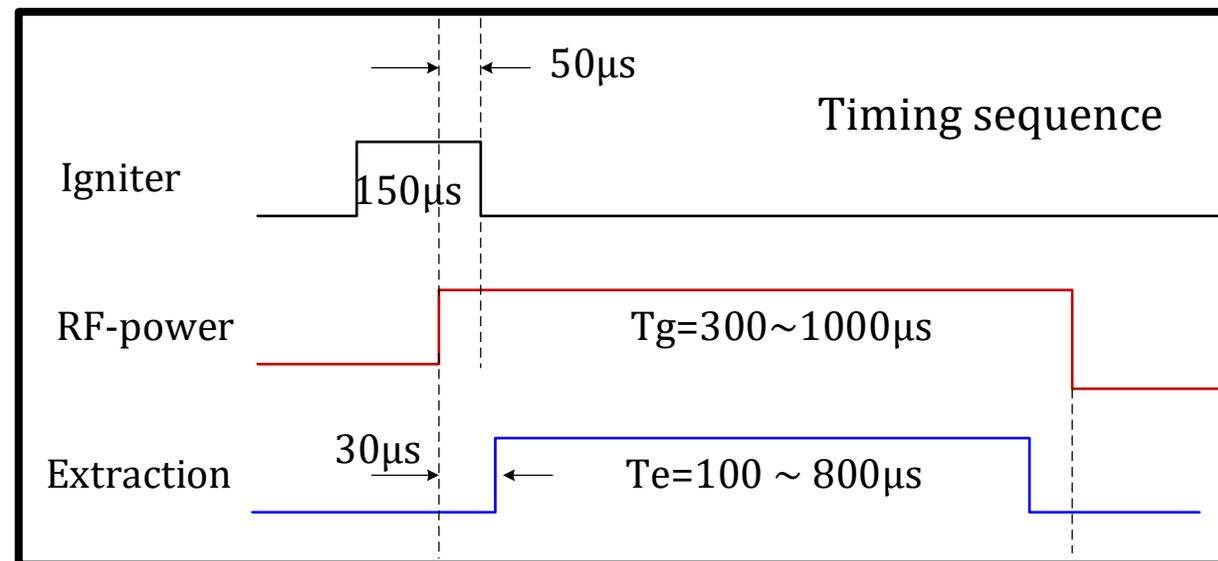
Structure of the ion source

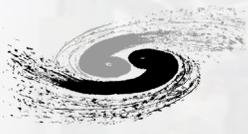
The glow discharge igniter

- Simple structure
- Pulsed 560 V DC voltage
- Average power less than 0.5 W



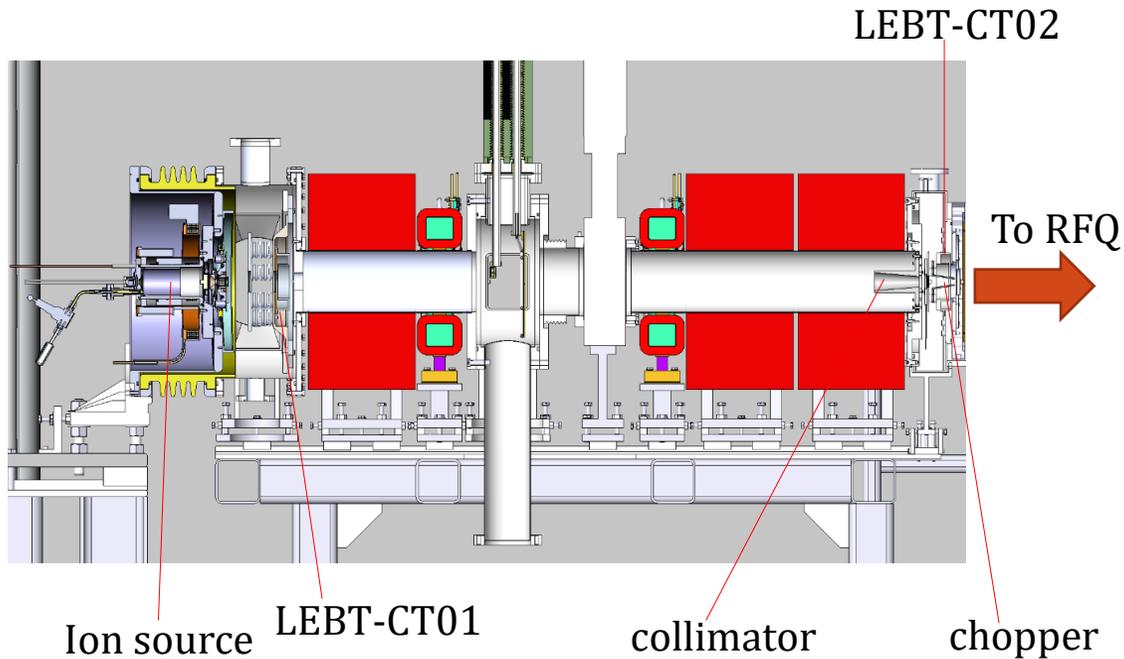
Since the pressure in the igniter is 200~400 Pa, the seed electrons are blown to the plasma chamber and guided by the weak axial magnetic field produced by the magnetic coil, which is mainly used to compensate the magnet field of solenoid in LEBT.



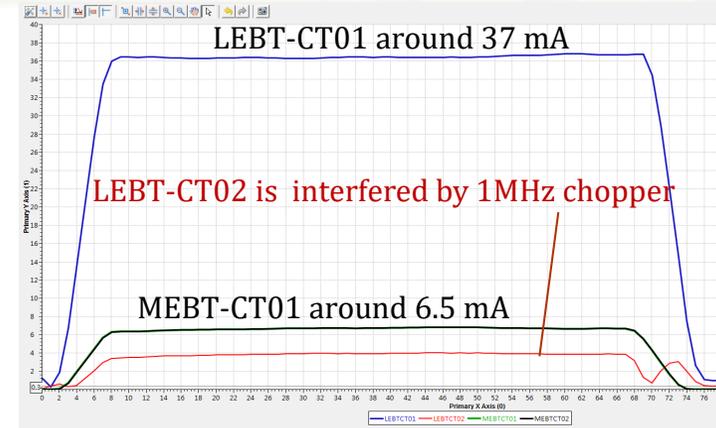


Operation status

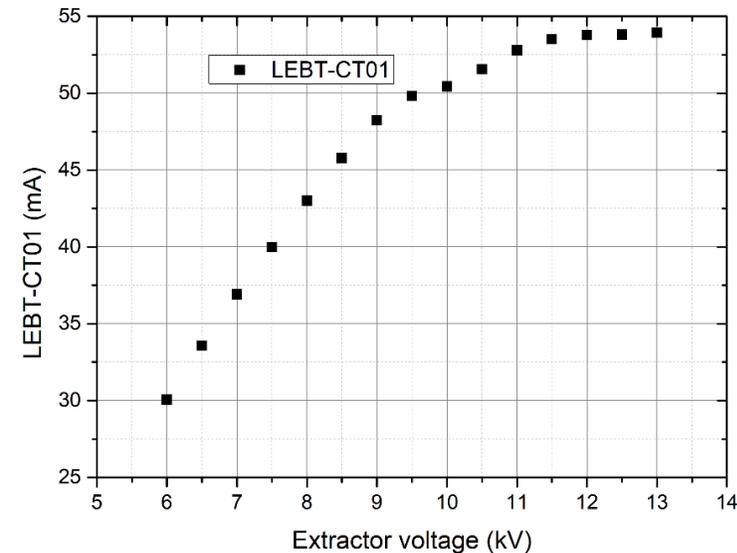
Low energy beam transport



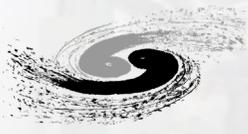
A new 2-solenoid LEBT is under construction, expected to be installed in the accelerator in 2024.



Typical current for 100 kW beam power operation

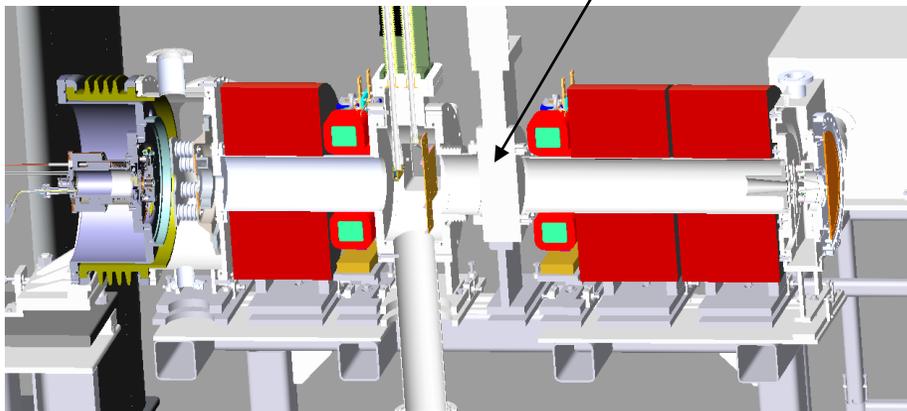
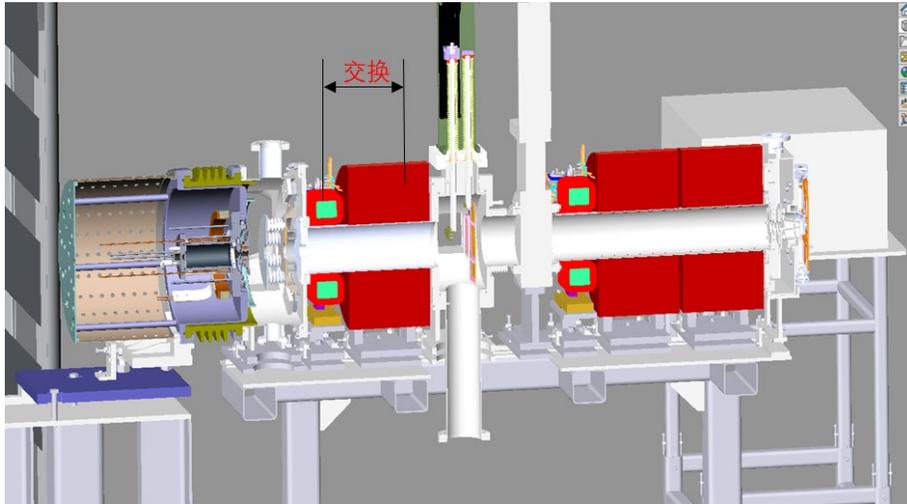


LEBT-CT01 vs extr. voltage
RF power=30-31 kW,
H2=21 SCCM
53mA is produced.

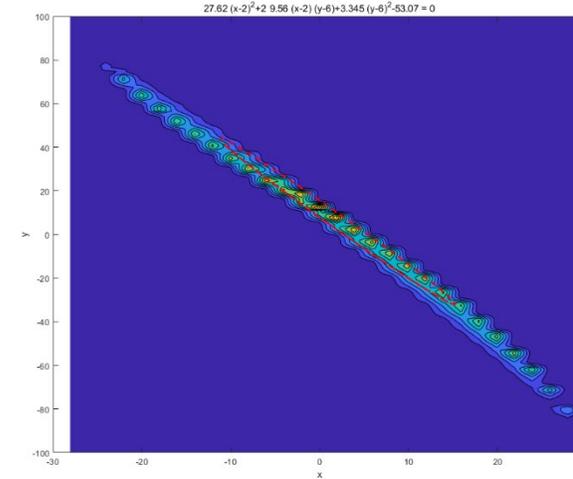


Operation status

Emittance measurement (in lab)

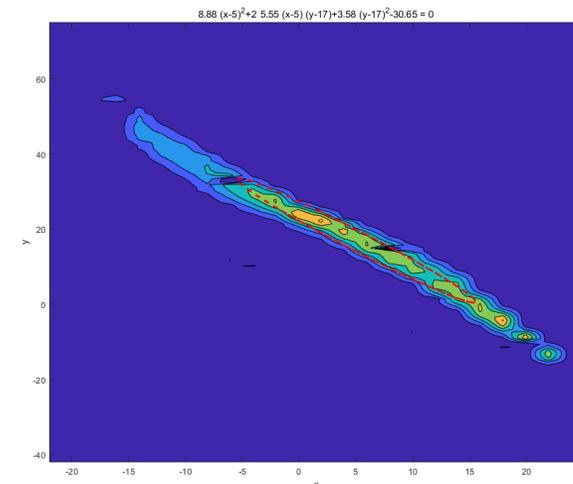


- The CST simulation shows that the emittance gets smaller when the solenoid is closer to the ion source.
- The possible reason is the envelope of the beam is smaller at the entrance of the solenoid. The aberration of the B-field is smaller when the beam is closer to the axis of the solenoid.
- The B-field at the double-slit scanner also contributes to the measured value of emittance.

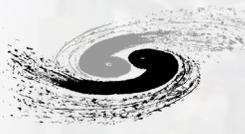


n-RMS emittance,
X-0.562 pi.mm.mrad
Y-0.531 pi.mm.mrad

magnets swapped

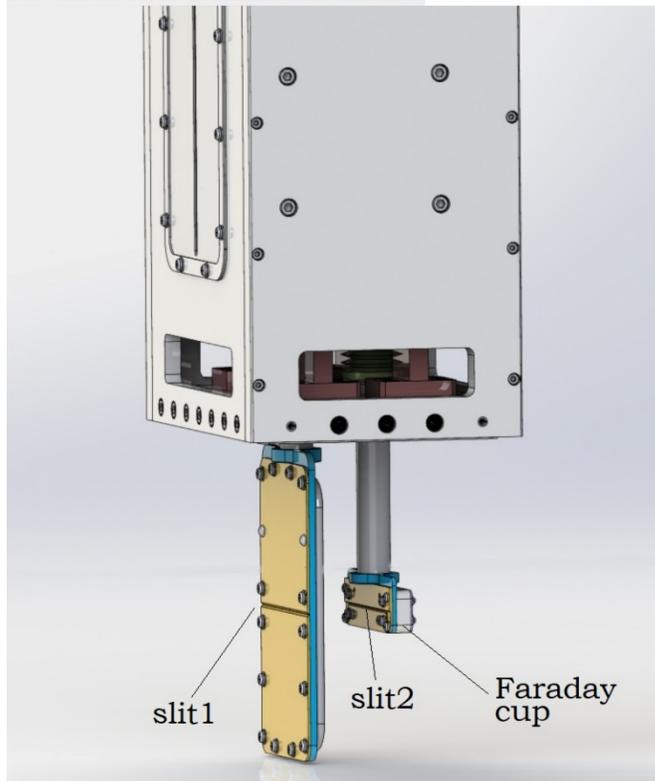


n-RMS emittance,
X-0.355 pi.mm.mrad
Y-0.307 pi.mm.mrad

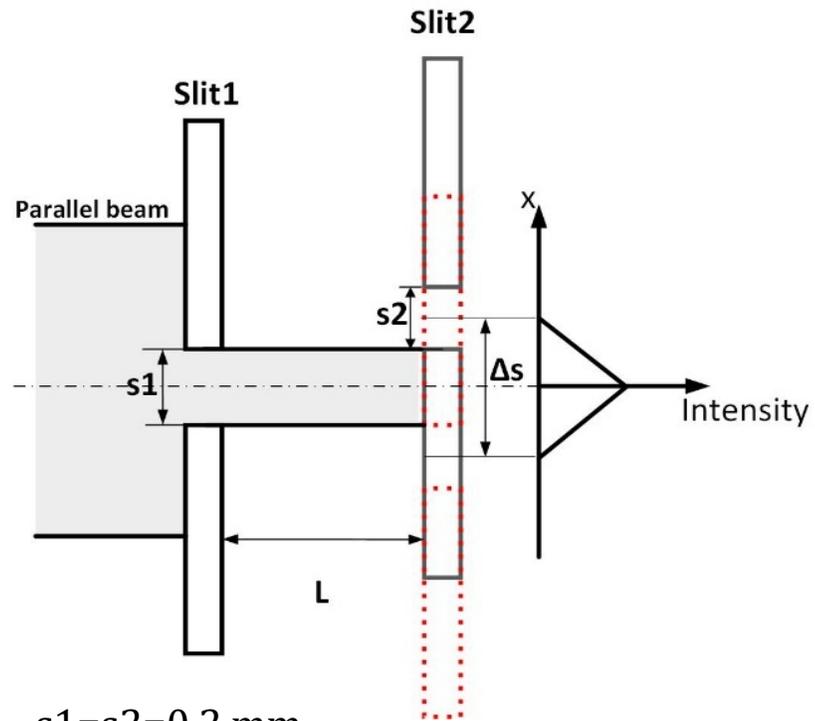


Operation status

Systematic error of double-slit scanner



Structure of the double-slit scanner



s1=s2=0.2 mm
L=52 mm
Minimum beam envelope~30-50 mm

The double-slit scanner itself will introduce extra emittance error comparable to the real value.

$$\Delta x'_i = \frac{\Delta s}{L} = \frac{s_1 + s_2}{L} = \Delta x',$$

$$A_x = S_{en} \cdot \Delta x',$$

The emittance error is $\Delta \epsilon_x = \frac{A_x}{\pi}$,

Solution:

- New LEBT for smaller beam envelope.
- New scanner with 0.1 mm slit width.

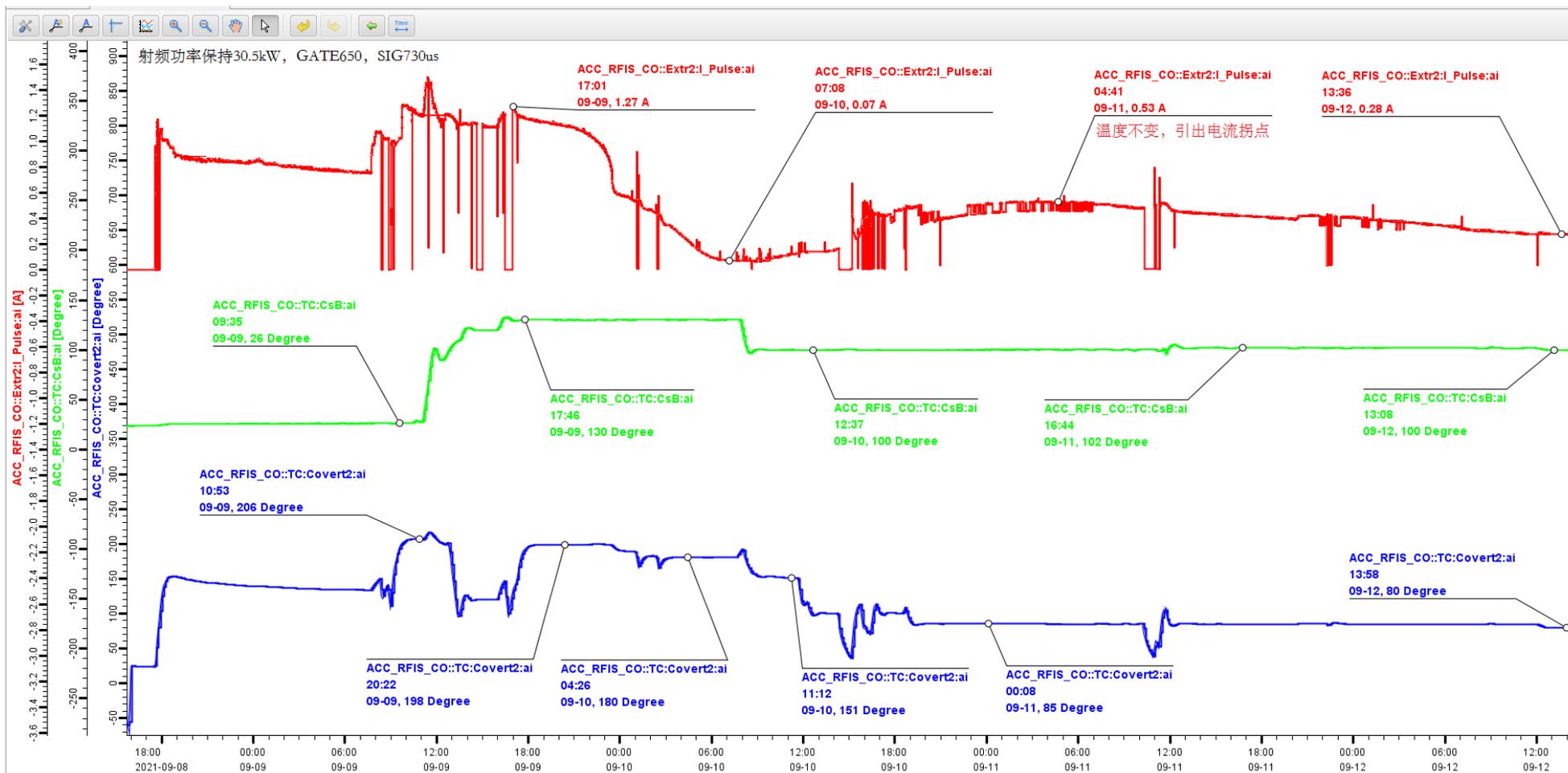
They will be ready for test in the lab by the end of this year.



Operation status

Since it was the first service cycle in CSNS accelerator, we run the source with caution. The cesiation process takes 3 days before it started to deliver the beam to the accelerator for machine study. The parameters are fixed after ~10 days.

Cesiation



Cs oven temperature
130 °C → 85 °C

Extracted e current:
1.27 A → 0.08 A

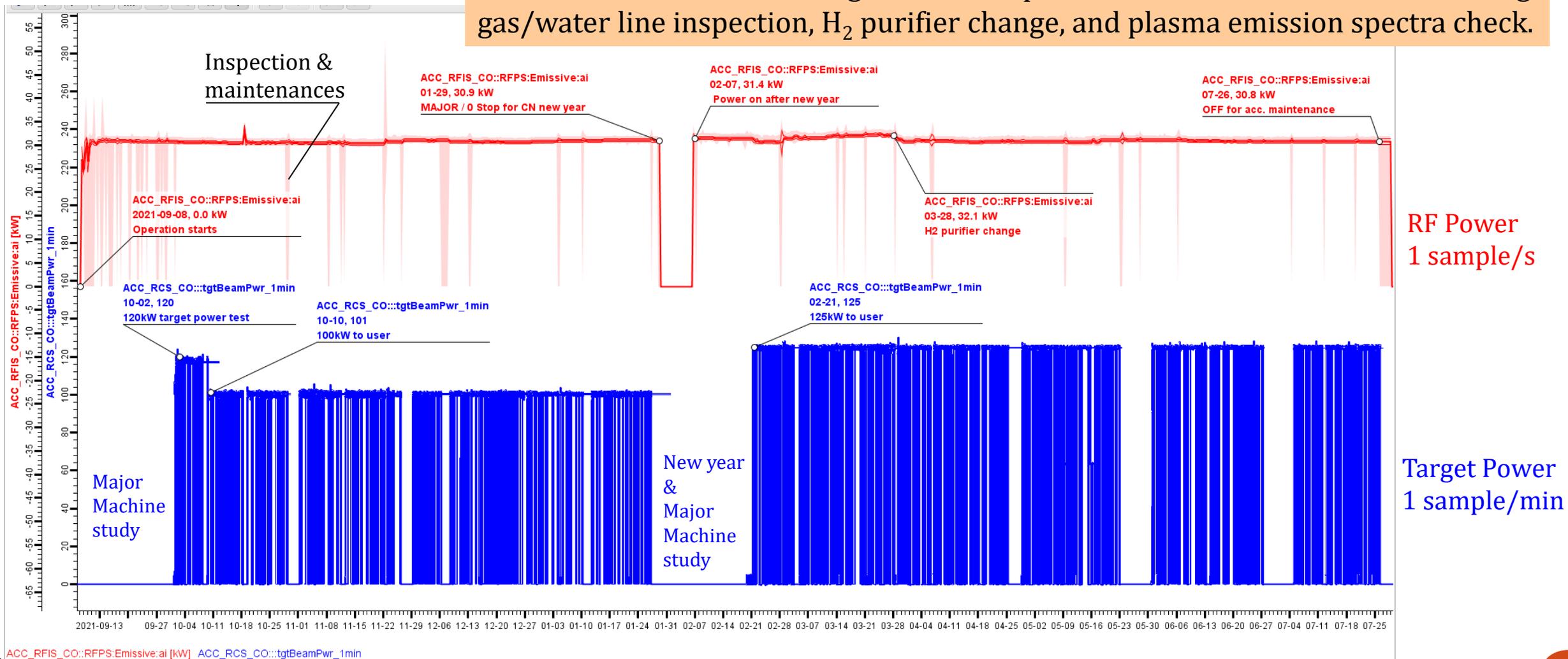
PE temperature:
200 °C → 80 °C

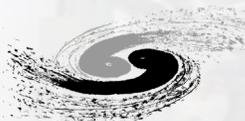


Operation status

~310 days of operation

The maintenance was done when the whole accelerator is closed for inspection. The maintenance includes gas bottle replacement, 50 kV insulation cleaning, gas/water line inspection, H₂ purifier change, and plasma emission spectra check.

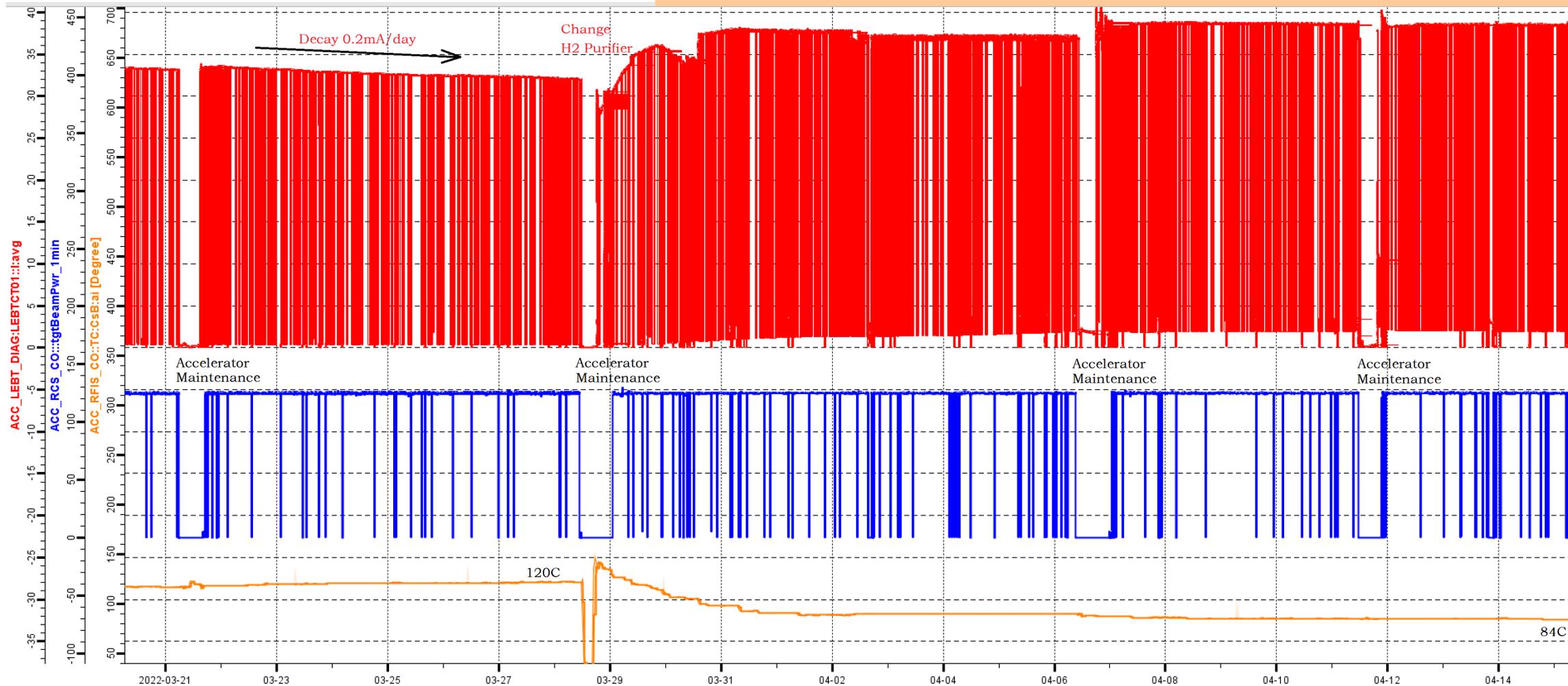




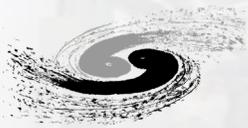
Issues in operation

Since Dec. 20th, 2021, 0777 spectrum starts to increase slowly. The extracted electron current also started to increase, and LEBT-CT01 started to decay. Consequently, the cesium oven temperature is increased step by step to compensate the current decay. Up to Mar. 28th, 2022 it is heated up to 120 °C. No leakage to vacuum is observed. After the H₂ purifier is changed, the ion source recovered to the same parameters as in the early stage.

Current decay and recovering



ACC_LEBT_DIAG:LEBTCT01::I:avg ACC_RCS_CO::tgtBeamPwr_1min ACC_RFIS_CO::TC:CsB:al [Degree]



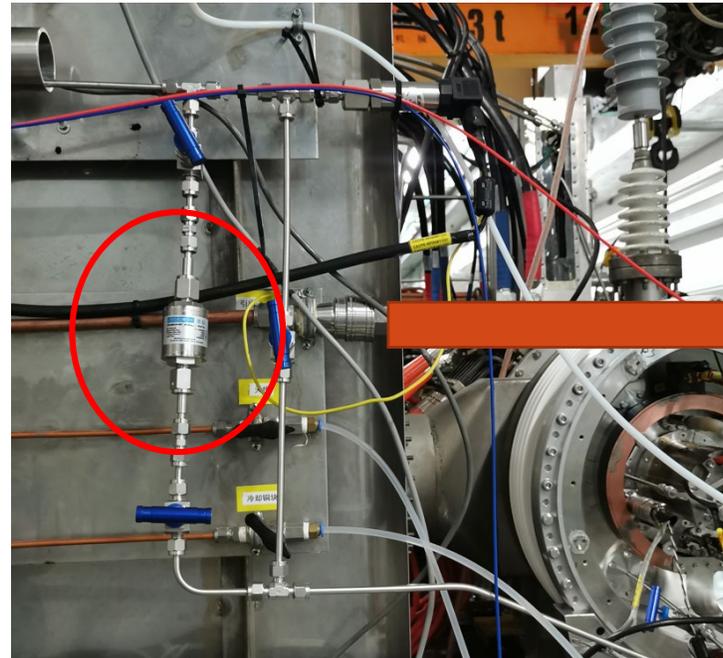
Issues in operation

Importance of vacuum condition and H₂ purifier

Typical H₂ consumption is 21 sccm, corresponding to ~10 m³ per year.

For H₂ of 9999.99% purity, contains ~10 ml water/O₂. *Extra ~0.24 g cesium is needed.*

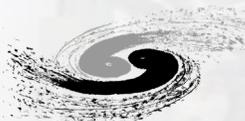
For H₂ of 999.99% purity, contains ~30 ml water/O₂. *Extra ~0.72 g cesium is needed!*



Changed to bigger one



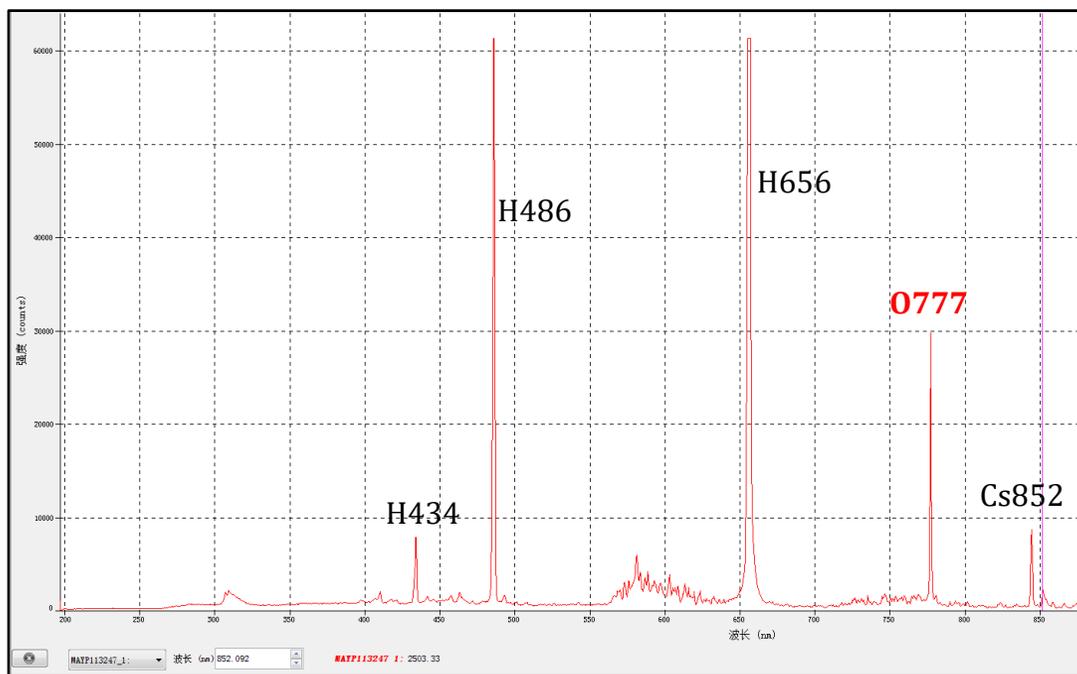
The hydrogen purifier eliminates the water/O₂ to less than 1 ppt according to the specification.



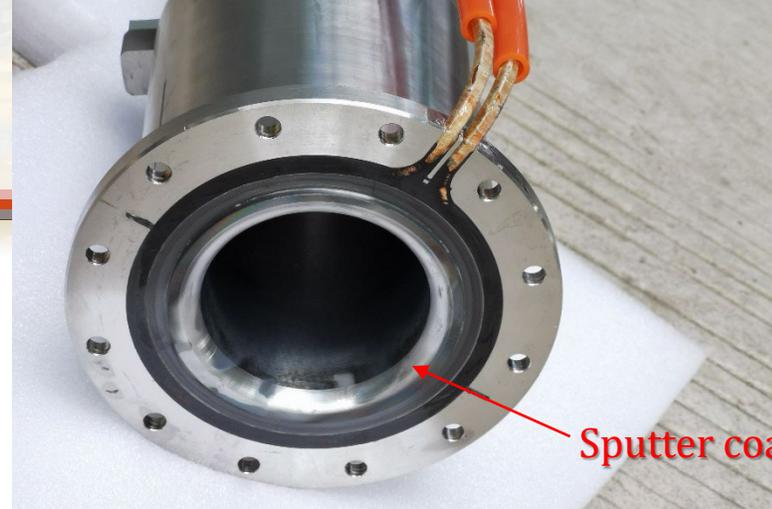
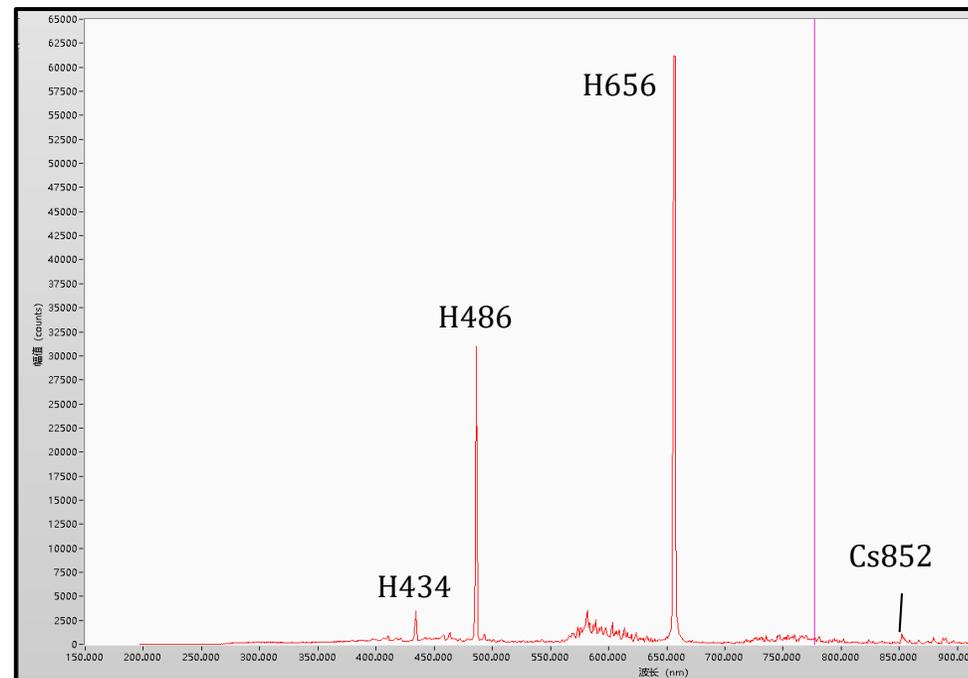
Issues in operation

Importance of vacuum condition and H₂ purifier

From 2019 to 2021, many efforts were made to decrease the O777 spectrum line. It is critical to increase the H-current, to decrease the co-extracted electron current, and to create a flat-top current pulse.



Effect of H₂ purifier
➔



Sputter coating

Big amount of oxygen element will cause the sputter erosion of electrodes in long term operation. The plasma chamber is coated with a layer of metal through sputtering, which changes the EM field distribution of the plasma.



Issues in operation and machine study

Cesium consumption measurement

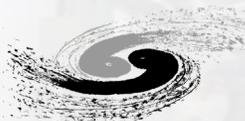
The ion source is dismantled in August 2022. The ion source was disassembled into pieces. All of the parts (except the cesium injection system) were put into a jar filled with diluted sulfuric acid to collect all of the cesium.

The volume of the solution is 320 ml. The concentration of cesium is 0.12%, measured with an ICP-MS.

0.38 g cesium is used in ~310 days of operation, which is a little higher than expected. The cesium oven temperature was raised from 85 °C gradually to 120 °C in 3 months to solve the problem caused by saturation of H₂ purifier.

Estimating from the vapor-temperature curve of the cesium, **less than 0.2g/year cesium will be used for normal operation.**





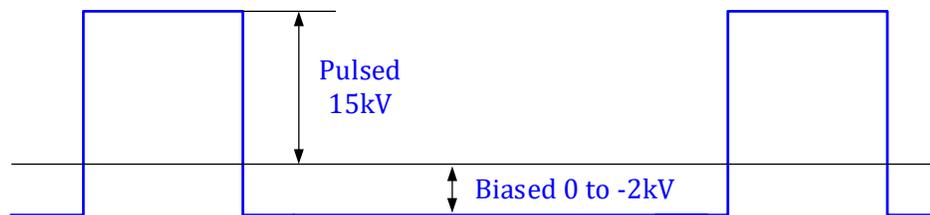
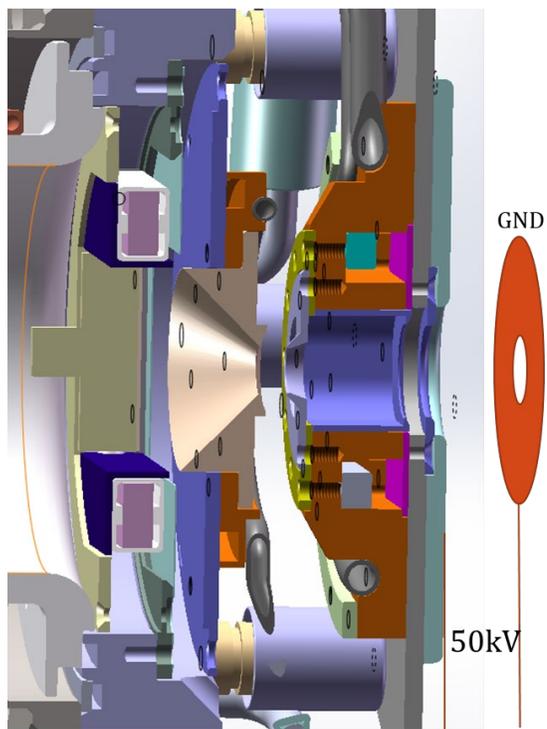
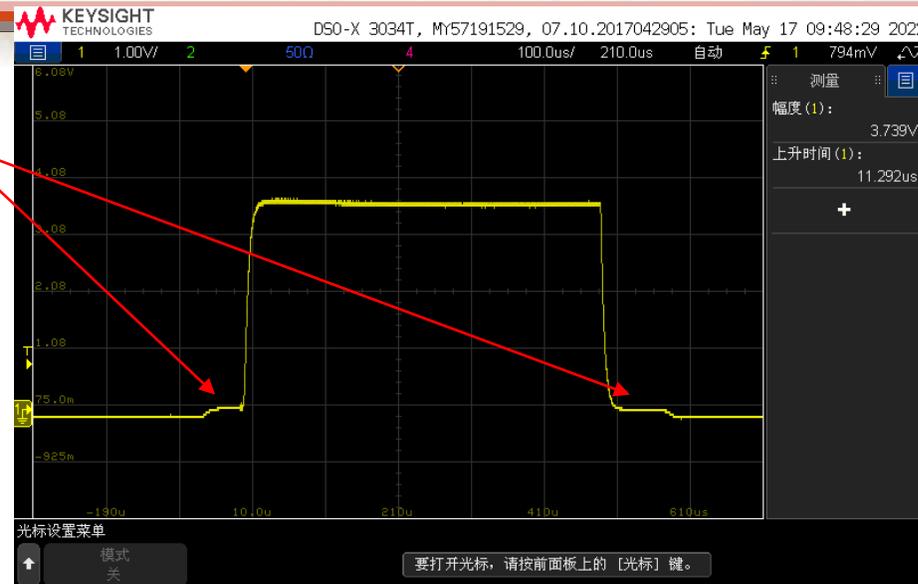
Issues in operation and machine study

Dark current

Origin of the dark current

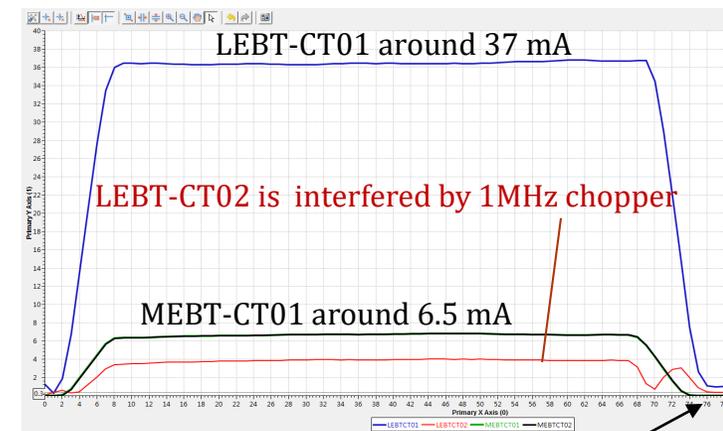
- Fringe electric field of the ground electrode penetrates through the extractor electrode.
- High energy H⁻ ions effuse from the PE aperture.

Dark current occurs when plasma is on and extractor is off

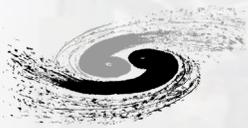


- Solution 1, bias extracting voltage negatively.
- Solution 2, timing the chopper before RFQ to deflect the dark current.

Dark current increase the beam loss of the RCS in injection period !

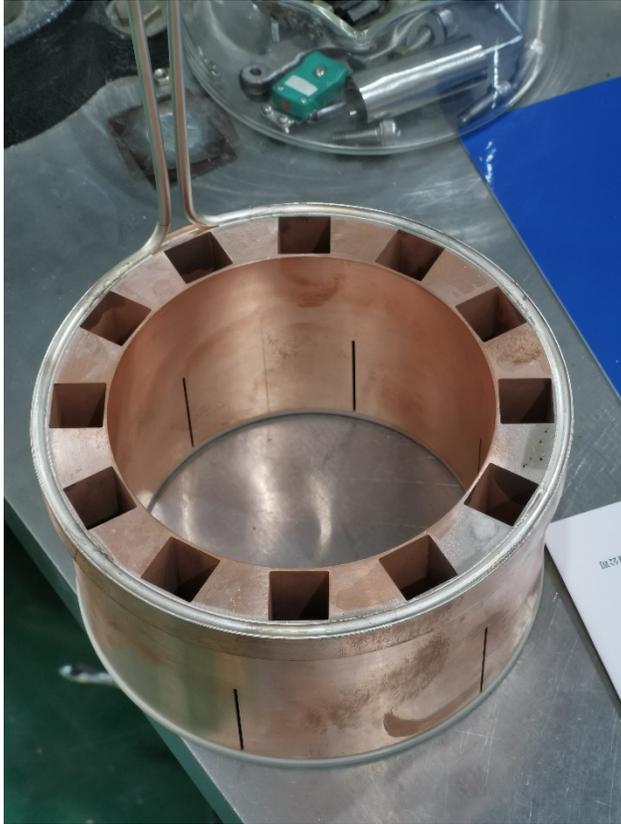


No dark current after RFQ

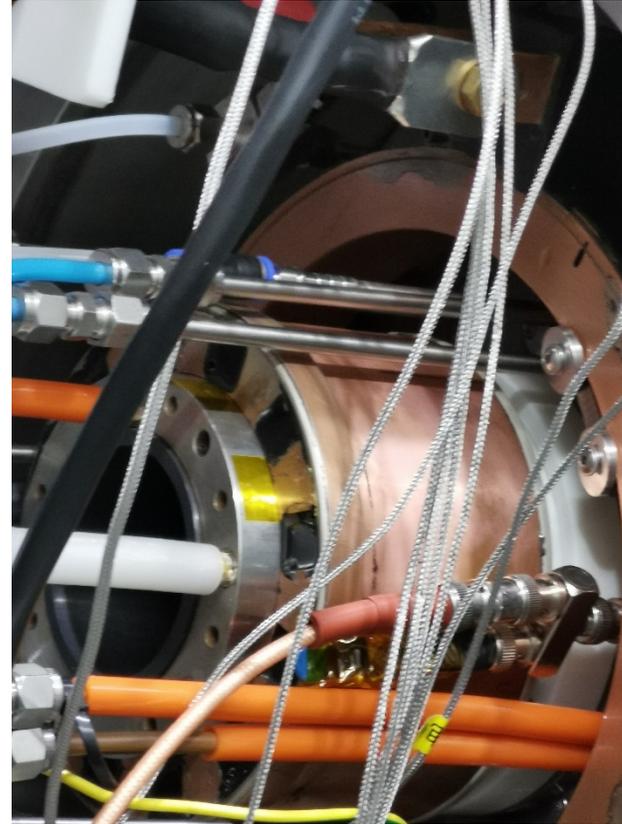


Issues in operation and machine study

Cusp magnets



Cusp magnet holder



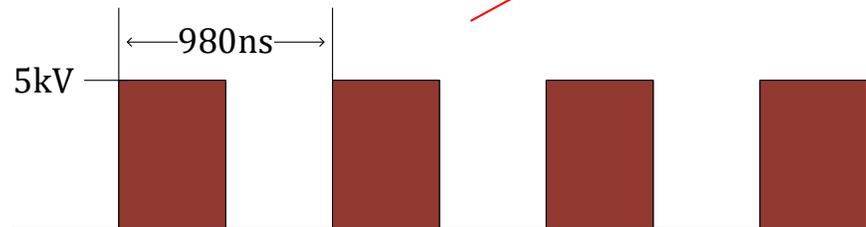
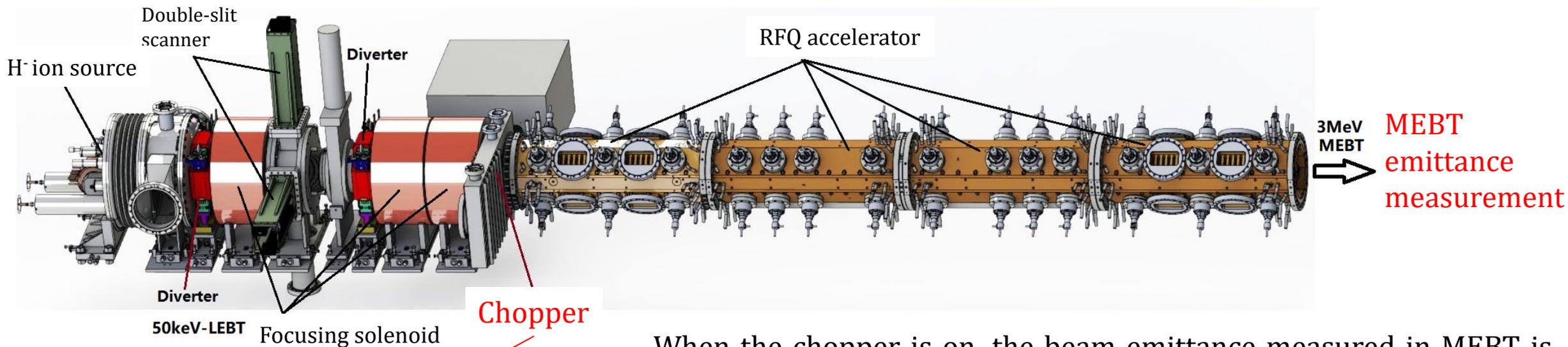
Cusp magnets were removed since 2021 due to:

1. Cusp field does not increase the beam production efficiency greatly in our test.
2. Cusp field interferes with axial field used to guide the seed electrons, making the plasma start failure occasionally, specially before Cs is injected.
3. Cusp field focuses ions into strips along the ceramic plasma chamber, producing hot and cold strips, which is not good for cesium transport. Strips of white compounds were observed after the chamber was exposed to air.



Issues in operation and machine study

Emittance growth caused by beam chopping



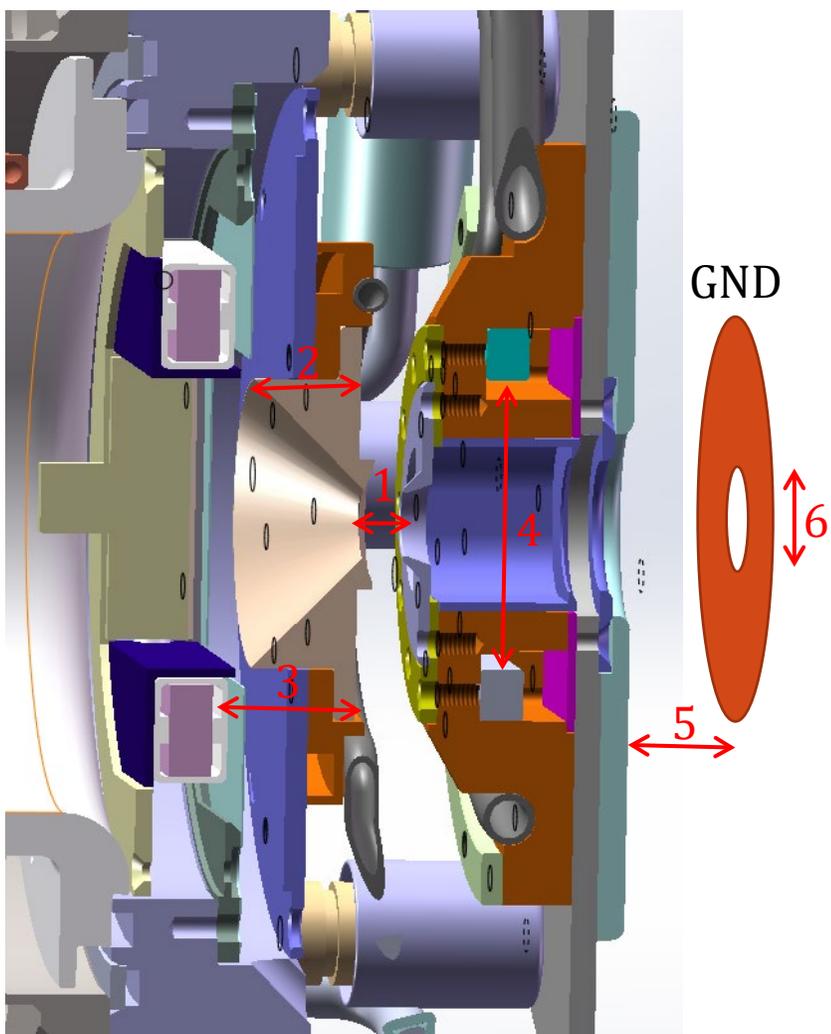
When the chopper is on, the beam emittance measured in MEBT is larger than that when chopper is off. The difference becomes obvious as the beam current increases. The reason behind is that the ~ 1 MHz chopper voltage destroys the H_2^+ ion cloud around the chopper. Consequently space charge compensation can not be built up around the chopper.

See more in poster Session 2 / 75 on Thursday.



Recent development

Optimization based on current structure



Changes in August 2022, guided by CST simulation

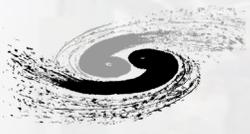
1. Extraction gap is increased to 3.7 mm
2. Thickness of PE electrode increased by 1 mm.
3. Distance from PE aperture to filter magnets increased by 1 mm.
4. Dumping magnet pair away by 1 mm.
5. Ground electrode closer by 8 mm.
6. Ground electrode inner diameter smaller by 2 mm.

Beam Transmission		
LEBT CT01	60.201	mA
LEBT CT02	0.121	mA
MEBT CT01	0.005	mA
MEBT CT02	0.018	mA

Beam Transmission		
LEBT CT01	52.623	mA
LEBT CT02	37.518	mA
MEBT CT01	35.177	mA
MEBT CT02	0.004	mA
LEBT Trans Efficiency	71.3	%
RFQ Trans Efficiency	93.8	%
MEBT Trans Efficiency	0.0	%

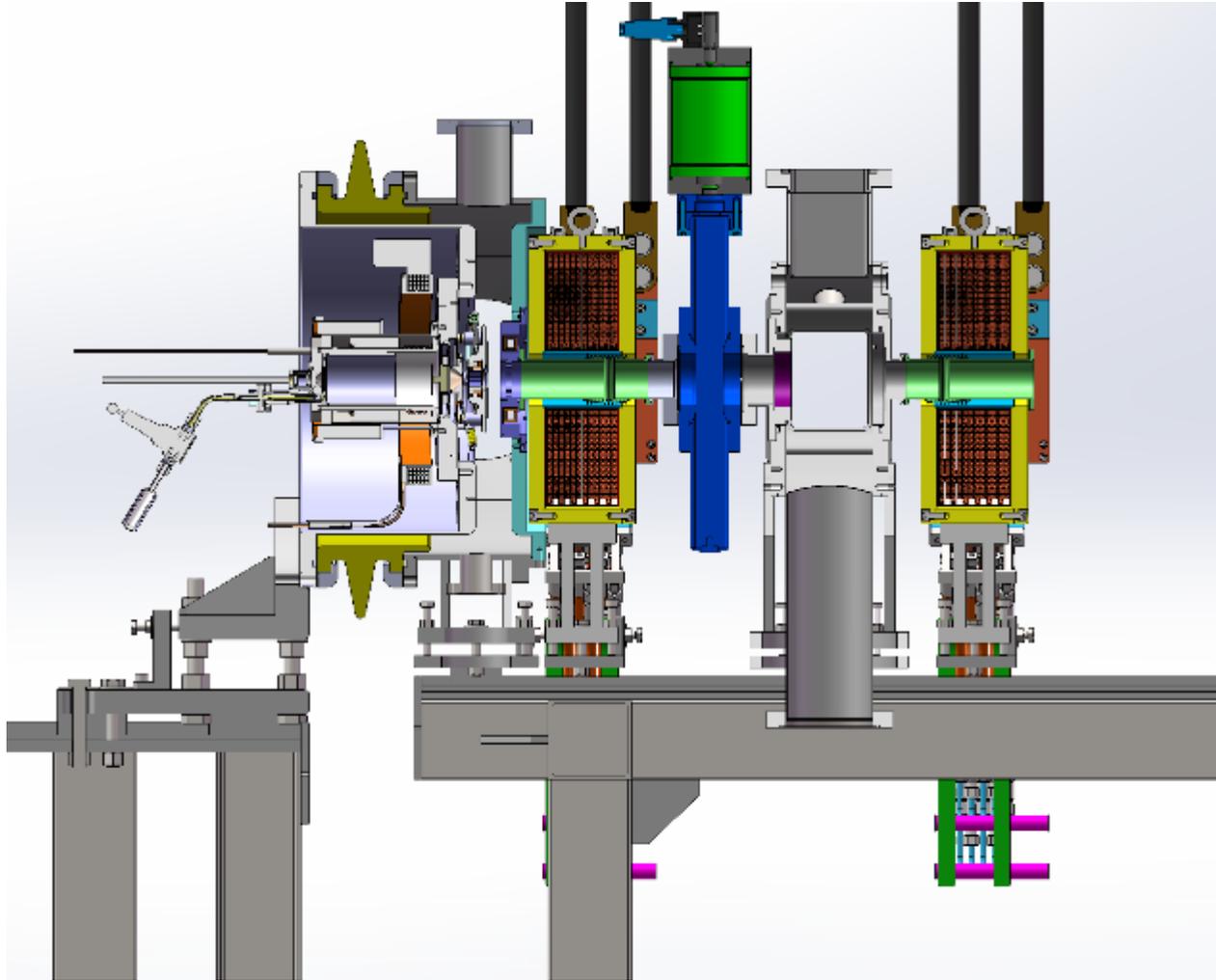
After the optimization, over 60 mA H⁻ beam is produced at 32 kW RF power, hydrogen flow rate 22 SCCM.

About 35.2 mA out from RFQ, limited by beam collimator in LEBT.

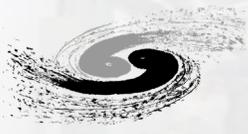


Recent development

New LEBT



- Double solenoids.
- Optimized emittance growth.
- Higher transmission efficiency.
- Less than 0.75 m length.
- New double-slit scanner with smaller slit width.
- Ready for test in lab by the end of this year.



Summary

- The RF-driven H^- ion source with external antenna and Si_3N_4 chamber runs successfully in CSNS. It has been operated more than 310 days (even longer).
- The glow discharge igniter in gas line works efficiently.
- Vacuum condition and H_2 purifier are very important to promote the performance of the beam, and to minimize the usage of cesium.
- Dark current is efficiently removed by biasing the extractor negatively, and chopping the rising/fall fringe of beam.
- Cusp field is removed from the H^- ion source since 2021.
- New LEPT is under construction, which will enhance the performance of the ion source.



Members of CSNS front end group

Thanks for your attention!



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